

William Heilhecker Memorial Scholarship Program

The Program

The William Heilhecker Memorial Scholarship Program was established to help finance higher education for the children/grandchildren of Bosch Packaging Technology, Inc. employees. The program is independently managed and awards are given without regard to race, religion, sex, disability or national origin.

Eligibility

This scholarship is for children/step-children/grandchildren/step-grandchildren of current, regular full-time Bosch Packaging Technology, Inc. employees (you will be required to show proof of relationship). Applicants must be either a high school senior or a first year college undergraduate enrolled or planning to enroll in a four-year accredited college or university. Other criteria is as follows:

- ▶ Application deadline is June 30, 2012.
- ▶ GPA (25%). A current complete transcript is required and must be submitted with the application. Grade reports are not acceptable. Online transcripts must display student name, school name, grade and credit hours earned for each course, and term in which each course was taken.
- ▶ ACT/SAT Scores (25%)
- ▶ Letter(s) of Recommendation by business and/or community leader(s) (50%)
- ▶ Must maintain a 3.0 GPA for each year (not cumulative), to receive the next year's scholarship
- ▶ If a recipient loses their scholarship due to low GPA and then raises it again to the 3.0 GPA minimum, they will receive their scholarship for the following year.

Scholarship Awards

2012 will be the last year that this scholarship will be awarded. It will be paid directly to the school in which the winning recipient is attending and will be divided between two semesters (minimum scholarship value of \$800). The total amount available may be divided between winning recipients as determined by the scholarship committee.

Application

Students must complete and submit the application, along with a complete high school or college grade transcript and letters of recommendation on or before June 30, 2012. Applicants are solely responsible for gathering and submitting all necessary information. All information submitted is confidential and will be reviewed only by the scholarship committee. Every complete application received by the required deadline will be given a fair and careful evaluation. Please keep a copy of the application, as they will not be returned.

Carefully review your completed application before it is submitted. We reserve the right to process only those applications found to be complete by the application deadline.

Recipient Selection

Scholarship recipients are selected on the basis of academic achievement and recommendations made by business and/or community leaders.

Scholarships awarded will be based on selection procedures and available funds. Not all applicants will receive awards.

Selection of recipients will be made by the scholarship committee.

All applicants will be notified whether or not they are selected as a recipient by July 6, 2012.

Payment of Awards

Scholarship payments are authorized and processed by the committee. Payments are made directly to the school in which the child has enrolled, to be divided equally for each semester.

Obligations

Scholarship recipients must enroll in their educational programs no later than the fall of the year in which their awards are given. Recipients have no obligations to Bosch Packaging Technology, Inc.

Revision Policy

The general conditions and procedures under which scholarships are made are subject to periodic review by the committee, including termination of the program.

For More Information:

E-Mail Scholarship@Heilhecker.com

Applications can be found at www.Heilhecker.com